

Absolute Maximum Ratings (Voltage relative to GND, @T_A = +25°C, unless otherwise specified.)

Characteristic	Symbol	Value	Unit
Input Voltage	V _{IN}	-0.3 to 60	V
Continuous Input & Output Current	I _{IN} , I _{OUT}	320	mA
Peak Pulsed Input & Output Current	I _{IM} , I _{OM}	2	A
Maximum Voltage applied to V _{OUT}	V _{OUT(max)}	Smaller of V _{IN} +5V or 13V	V

Maximum Current at V_{IN} = 24V (@T_A = +25°C, unless otherwise specified.)

Characteristic	Symbol	Value	Unit
Continuous Output Current (Note 7)	I _{OUT}	40	mA
Pulsed Output Current (Note 8)	I _{OM}	2,000	mA
(Note 9)		375	

Thermal Characteristics

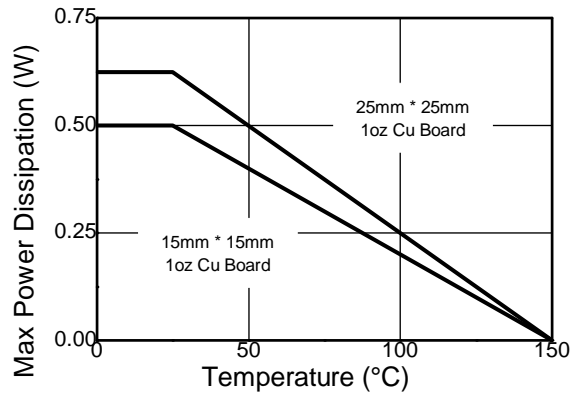
Characteristic	Symbol	Value	Unit
Power Dissipation (Note 5)	P _D	625	mW
(Note 6)		500	
Thermal Resistance, Junction to Ambient (Note 5)	R _{θJA}	200	°C/W
(Note 6)		250	
Thermal Resistance, Junction to Lead (Note 10)	R _{θJL}	197	
Thermal Resistance, Junction to Case (Note 10)	R _{θJC}	17	
Maximum Operating Junction and Storage Temperature Range	T _J , T _{STG}	-65 to +150	°C

ESD Ratings (Note 11)

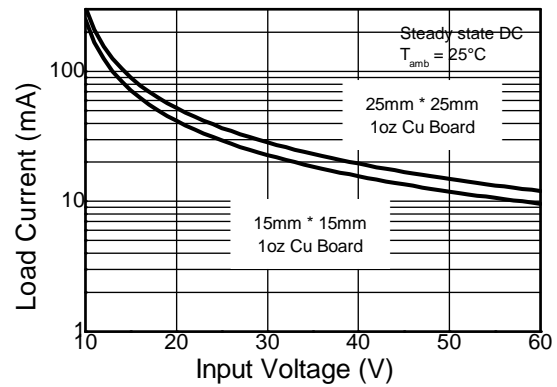
Characteristics	Symbols	Value	Unit	JEDEC Class
Electrostatic Discharge – Human Body Model	ESD HBM	4,000	V	3A
Electrostatic Discharge – Machine Model	ESD MM	400	V	C

- Notes:
- For a device mounted with the V_{IN} lead on 25mm x 25mm 1oz copper that is on a single-sided 1.6mm FR4 PCB; device is measured under still air conditions whilst operating in steady-state.
 - Same as note 5, except mounted on 15mm x 15mm 1oz copper.
 - Same as note 5, whilst operating at V_{IN}=24V. Refer to Safe Operating Area for other Input Voltages.
 - Same as note 5, except measured with a single pulse width = 100μs and V_{IN}=24V.
 - Same as note 5, except measured with a single pulse width = 10ms and V_{IN}=24V.
 - R_{θJL} = Thermal resistance from junction to solder-point (at the end of the V_{IN} lead).
 - R_{θJC} = Thermal resistance from junction to the top of case.
 - Refer to JEDEC specification JESD22-A114 and JESD22-A115.

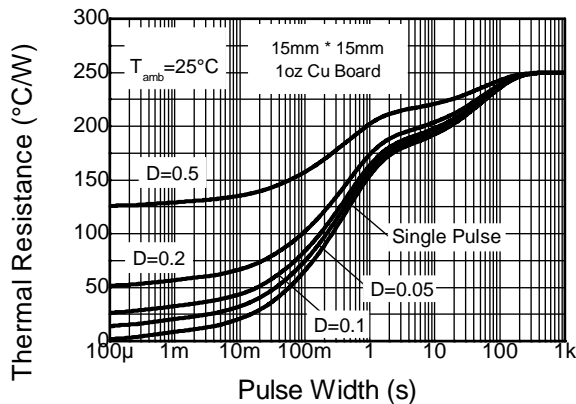
Thermal Characteristics and Derating Information



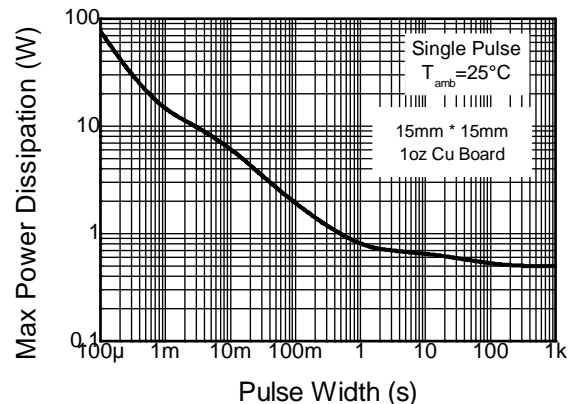
Derating Curve



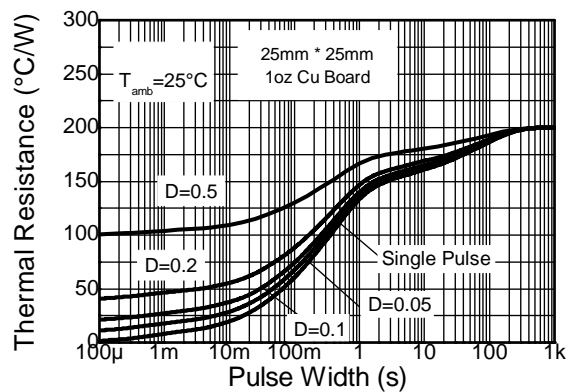
Safe Operating Area



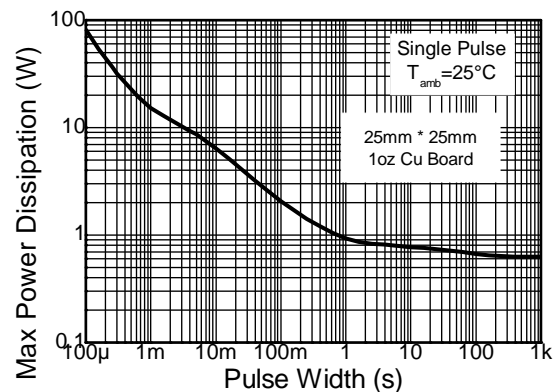
Transient Thermal Impedance



Pulse Power Dissipation



Transient Thermal Impedance



Pulse Power Dissipation

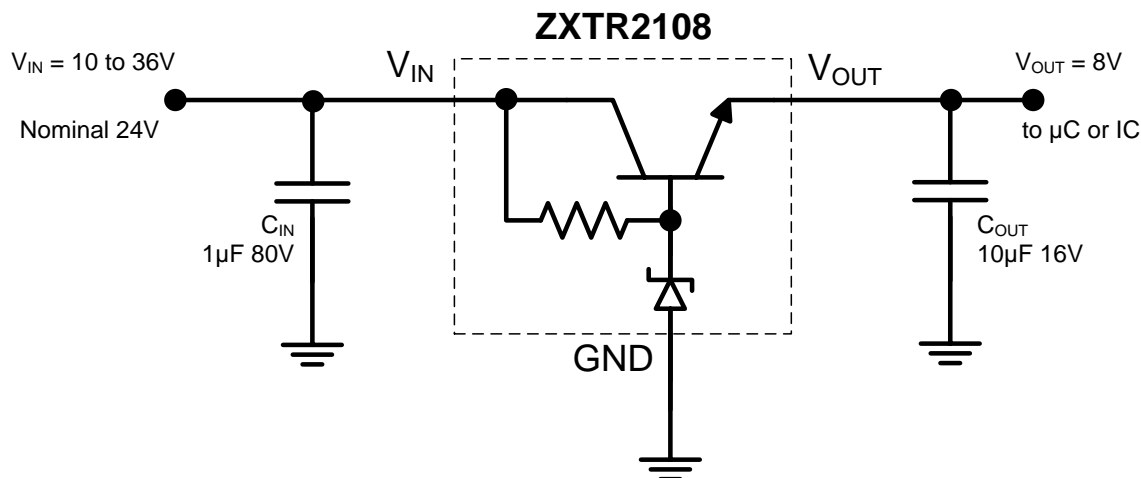
Electrical Characteristics (@T_A = +25°C, unless otherwise specified.)

Characteristic	Symbol	Min	Typ	Max	Unit	Test Condition
Output Voltage (Note 12)	V _{OUT}	7.2	8	8.8	V	V _{IN} = 24V, I _{OUT} = 15mA
Line Regulation (Notes 12 & 13)	ΔV _{OUT}	—	15	50	mV	V _{IN} = 18 to 24V, I _{OUT} = 15mA
		—	110	-		V _{IN} = 12 to 60V, I _{OUT} = 15mA
		—	120	-		V _{IN} = 10 to 60V, I _{OUT} = 15mA
		—	—	—		V _{IN} = 10 to 60V, I _{OUT} = 15mA
Temperature Coefficient	ΔV _{OUT} /ΔT	—	7.2	—	mV/°C	T _J = -40°C to +125°C V _{IN} = 24V, I _{OUT} = 15mA
Load Regulation (Notes 12 & 14)	ΔV _{OUT}	—	-16 -150	-50 -300	mV	I _{OUT} = 10 to 20mA, V _{IN} = 24V I _{OUT} = 0.1 to 50mA, V _{IN} = 24V
Minimum Value of Input Voltage Required to Maintain Line Regulation	V _{IN(MIN)}	10	—	—	V	—
Quiescent Current	I _Q	—	260 3,700	500 6,000	μA	V _{IN} = 12V, I _{OUT} = 10μA V _{IN} = 60V, I _{OUT} = 10μA
Power Supply Rejection Ratio	ΔV _{IN} /ΔV _{OUT}	—	45	—	dB	C _{OUT} = 100nF, I _{OUT} = 15mA, V _{OUT} = 8V, V _{IN} = 10 to 60V, f = 100Hz

Notes: 12. Measured under pulsed conditions. Pulse width ≤ 300μs. Duty cycle ≤ 2%.

13. Line regulation
 $\Delta V_{OUT} = V_{OUT}(@V_{IN}=24V) - V_{OUT}(@V_{IN} = 18V)$
 $\Delta V_{OUT} = V_{OUT}(@V_{IN}=60V) - V_{OUT}(@V_{IN} = 10V)$
 $\Delta V_{OUT} = V_{OUT}(@V_{IN}=60V) - V_{OUT}(@V_{IN} = 12V)$
14. Load regulation
 $\Delta V_{OUT} = V_{OUT}(@I_{OUT} = 20mA) - V_{OUT}(@I_{OUT} = 10mA)$
 $\Delta V_{OUT} = V_{OUT}(@I_{OUT} = 50mA) - V_{OUT}(@I_{OUT} = 0.1mA)$

Typical Application Circuit

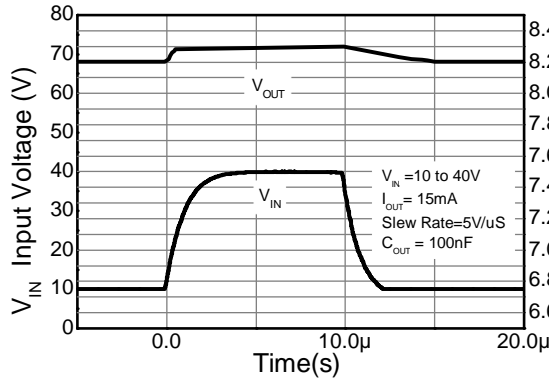


Example of a 8V regulated supply from a nominal 24V for powering a Controller IC.

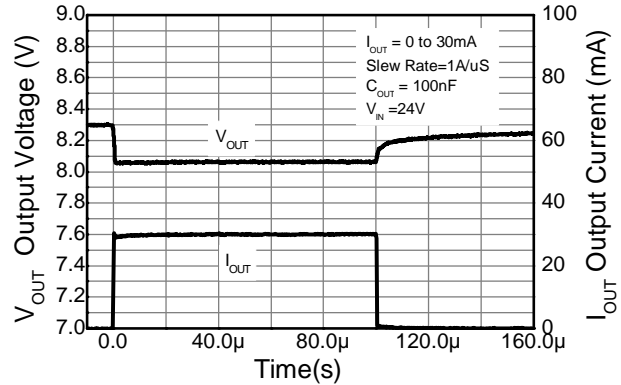
Pin Function

Pin Name	Pin Function	Notes
V _{IN}	Input Supply	Input voltage can vary from -0.3V to 60V with respect to GND; for V _{OUT} regulated then 10V ≤ V _{IN} ≤ 60V. It is recommended to connect a 1μF capacitor to GND.
GND	Power Ground	This pin should be tied to the system ground.
V _{OUT}	Voltage Output	Outputs a regulated 8V when 10V ≤ V _{IN} ≤ 60V. When V _{IN} < 10V, then V _{OUT} maximum = V _{IN} - 1V. The pin can be pulled high to a maximum of +13V with respect to GND, or +5V with respect to V _{IN} , whichever is lower. It is recommended to connect a 10μF capacitor to GND and a minimum of 10μA to be drawn from V _{OUT} to maintain regulation.

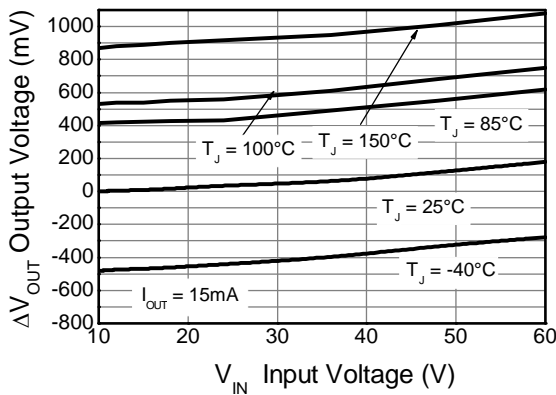
Typical Electrical Characteristics (@ $T_A = +25^\circ\text{C}$, unless otherwise specified.)



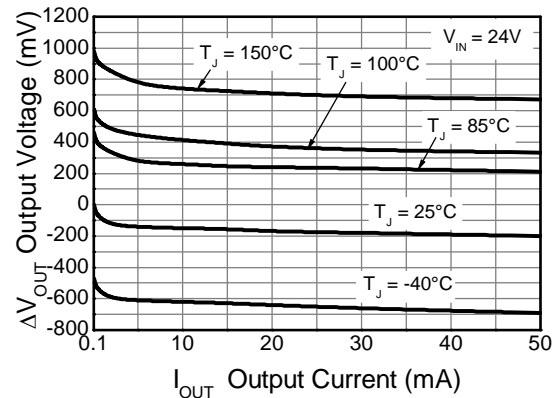
Line transient response



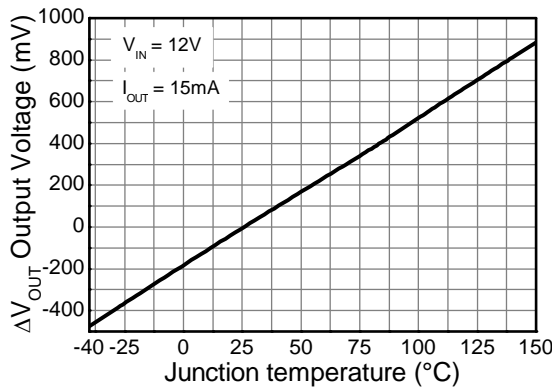
Load transient response



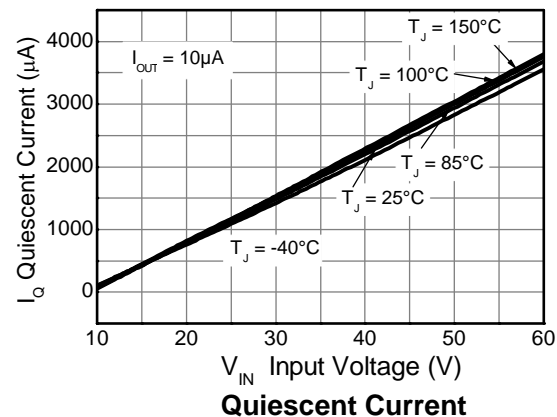
Line Regulation (Note 15)



Load Regulation (Note 16)



Temperature Coefficient (Note 17)

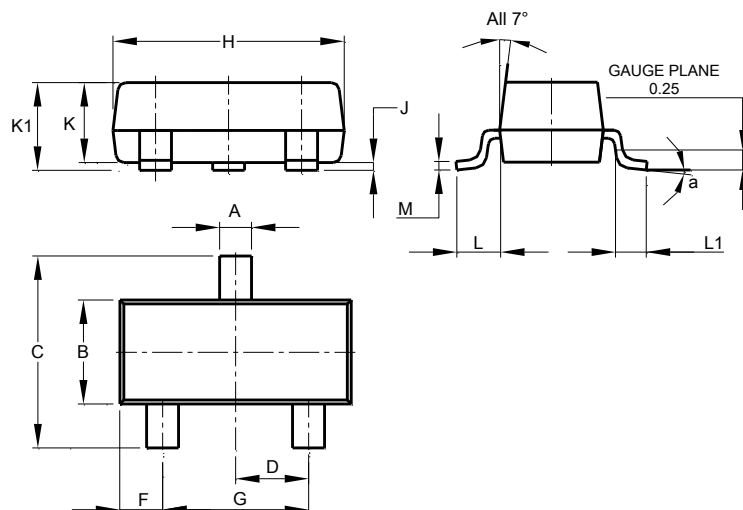


Quiescent Current

Notes:
15. Line Regulation $\Delta V_{OUT} = V_{OUT} - V_{OUT} (@ V_{IN} = 10V, I_{OUT} = 15mA, T_J = +25^\circ\text{C})$.
16. Load Regulation $\Delta V_{OUT} = V_{OUT} - V_{OUT} (@ V_{IN} = 24V, I_{OUT} = 0.1mA, T_J = +25^\circ\text{C})$.
17. Temperature Coefficient $\Delta V_{OUT} = V_{OUT} - V_{OUT} (@ V_{IN} = 24V, I_{OUT} = 15mA, T_J = +25^\circ\text{C})$.

Package Outline Dimensions

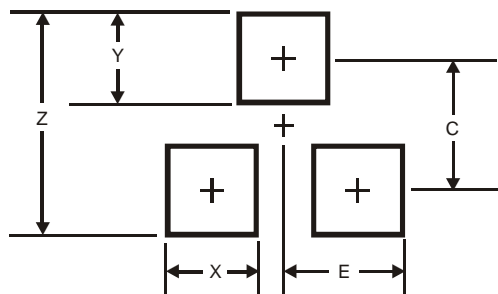
Please see AP02002 at <http://www.diodes.com/datasheets/ap02002.pdf> for the latest version.



SOT23			
Dim	Min	Max	Typ
A	0.37	0.51	0.40
B	1.20	1.40	1.30
C	2.30	2.50	2.40
D	0.89	1.03	0.915
F	0.45	0.60	0.535
G	1.78	2.05	1.83
H	2.80	3.00	2.90
J	0.013	0.10	0.05
K	0.890	1.00	0.975
K1	0.903	1.10	1.025
L	0.45	0.61	0.55
L1	0.25	0.55	0.40
M	0.085	0.150	0.110
a	8°		
All Dimensions in mm			

Suggested Pad Layout

Please see AP02001 at <http://www.diodes.com/datasheets/ap02001.pdf> for the latest version.



Dimensions	Value (in mm)
Z	2.9
X	0.8
Y	0.9
C	2.0
E	1.35

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